General Description

FSMOS® 46:-,; PZIHZLKV 6YPL HS:LTPJVKJVYZ PXLKLPJLKLZPNVHJOPLL low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. The low V_{th} series is specially designed to use in synchronous rectification power systems with low driving voltage.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent reliability and uniformity
- Fast switching and soft recovery

RoHS compliant

Applications

- PD charger
- Motor driver
- Switching voltage regulator
- DC-DC convertor
- Switched mode power supply

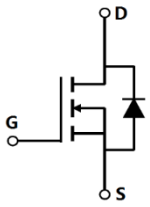
Key Performance Parameters

Parameter	Value	Unit
$V_{DS,\ min}$ @ $T_{j(max)}$	60	V
$I_{D,\ pulse}$	210	A
$R_{DS(ON)\ max}$ @ V_{GS}=10V	6	T
Q_g	30	nC

Marking Information

Product Name	Package	Marking
SFS06R06PF	TO220	SFS06R06P

Package & Pin information



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Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	60	V
Gate source voltage	V_{GS}	±20	V
Continuous drain current[1], T_C=25 °C	I_D	70	A
Pulsed drain current[2], T_C=25 °C	$I_{D, pulse}$	210	A
Continuous diode forward current[1], T_C=25 °C	I_S	70	A
Diode pulsed current[2], T_C=25 °C	$I_{S, Pulse}$	210	A
Power dissipation[3], T_C=25 °C	P_D	87	W
Single pulsed avalanche energy[5]	E_{AS}	66	mJ
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	R $_{1}$	1.44	°C/W
Thermal resistance, junction-ambient[4]	R $_{1(}$	62	°C/W

Electrical Characteristics at T_j=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	60			V	V_{GS}=0 V, I_D=250 A
Gate threshold voltage	$V_{GS(th)}$	1.0		2.5	V	V_{DS}=V_{GS}, I_D=250 A
Drain-source on-state resistance	$R_{DS(ON)}$		4.7	6	T	V_{GS}=10 V, I_D=20 A
Drain-source on-state resistance	$R_{DS(ON)}$		6.4	10	T	V_{GS}=4.5 V, I_D=10 A
Gate-source leakage current	I_{GSS}			100	nA	V_{GS}=20 V
				-100		V_{GS}=-20 V
Drain-source leakage current	I_{DSS}			1	A	V_{DS}=60 V, V_{GS}=0 V
Gate resistance	R_G		2.8			4 / a 6 WL KYHP

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Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		2136		pF	V_{GS}=0 V, V_{DS}=50 V, kHz
Output capacitance	C_{oss}		332		pF	
Reverse transfer capacitance	C_{rss}		10.6		pF	
Turn-on delay time	$t_{d(on)}$		22.9		ns	V_{GS}=10 V, V_{DS}=50 V, R_G I_D=25 A
Rise time	t_r		6.5		ns	
Turn-off delay time	$t_{d(off)}$		45.7		ns	
Fall time	t_f		20.4		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		30		nC	V_{GS}=10 V, V_{DS}=50 V, I_D=25 A
Gate-source charge	Q_{gs}		5.8		nC	
Gate-drain charge	Q_{gd}		6.1		nC	
Gate plateau voltage	$V_{plateau}$		3.6		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V_{SD}			1.3	V	I_S=20 A, V_{GS}=0 V
Reverse recovery time	t_{rr}		50.3		ns	V_R=50 V, I_S=25 A, KPK (Z
Reverse recovery charge	Q_{rr}		45.1		nC	
Peak reverse recovery current	I_{rrm}		1.5		A	

Note

1) Calculated continuous current based on maximum allowable junction temperature.
2) Repetitive rating; pulse width limited by max. junction temperature.
3) Pd is based on max. junction temperature, using junction-case thermal resistance.
4) The value of R $_{1(}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
5) V_{DD}=30 V,V_{GS}=10 V, L=0.3 mH, starting T_j=25 °C.

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Electrical Characteristics Diagrams

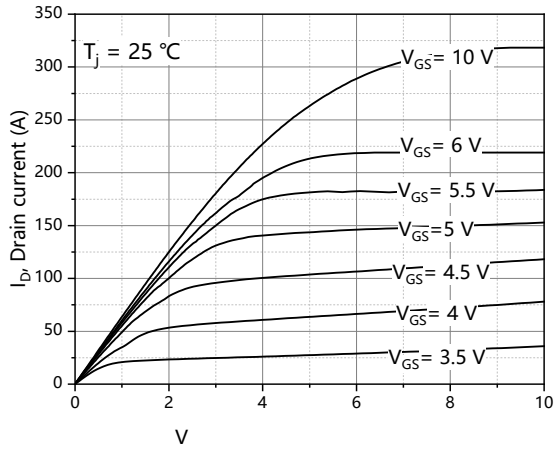

Figure 1. Typ. output characteristics

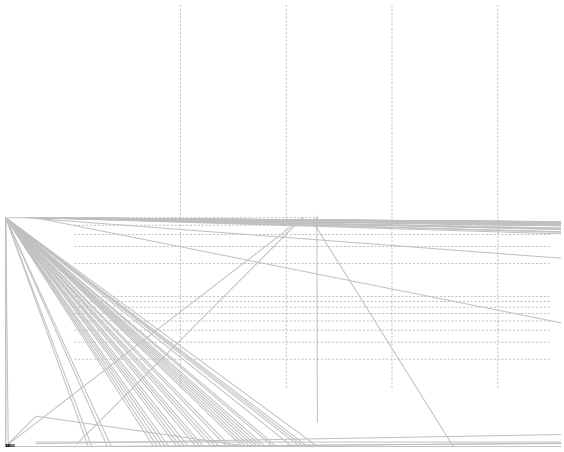

Figure 2. Typ. transfer characteristics

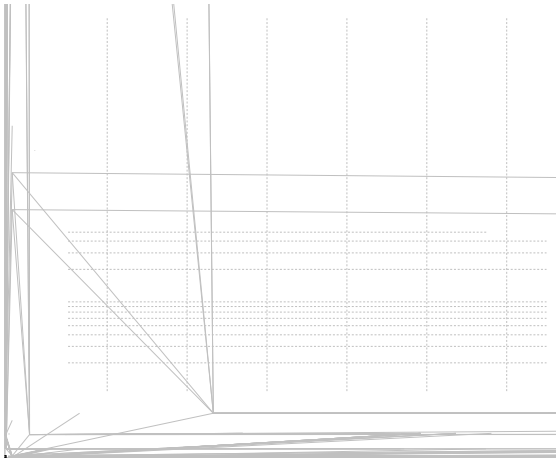

Figure 3. Typ. capacitances

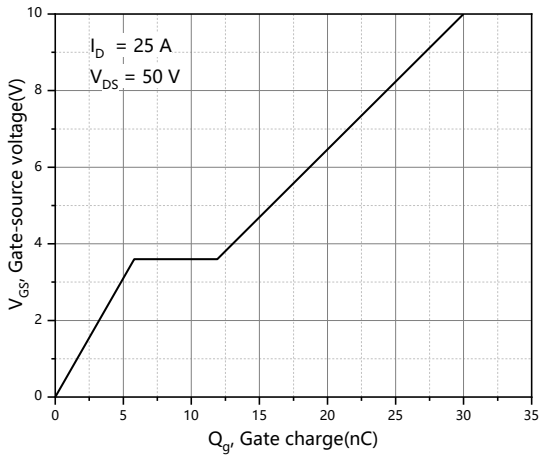

Figure 4. Typ. gate charge

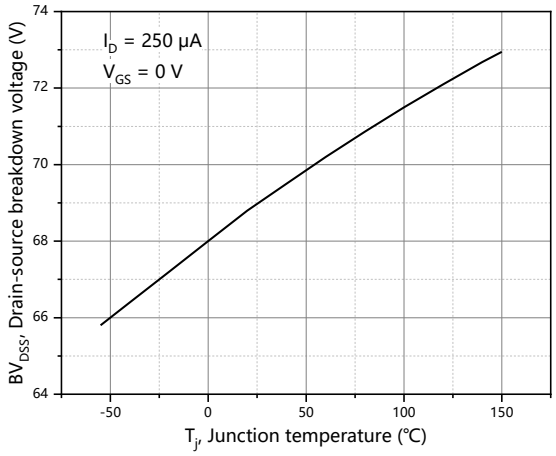

Figure 5. Drain-source breakdown voltage

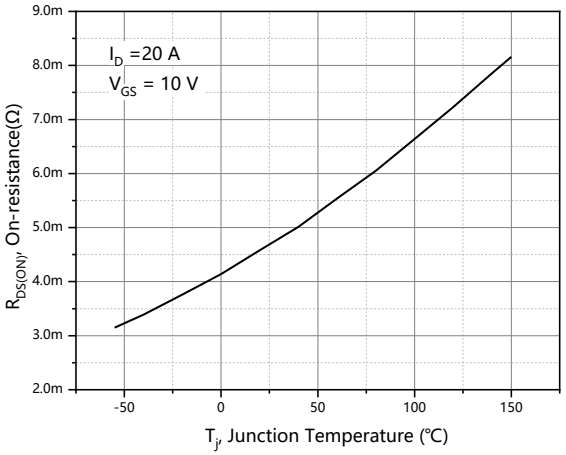

Figure 6. Drain-source on-state resistance

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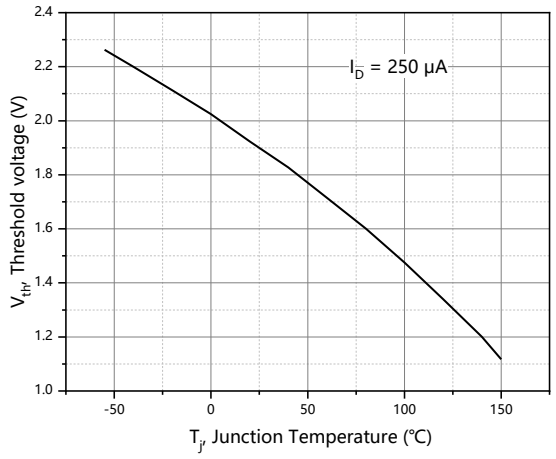

Figure 7. Threshold voltage

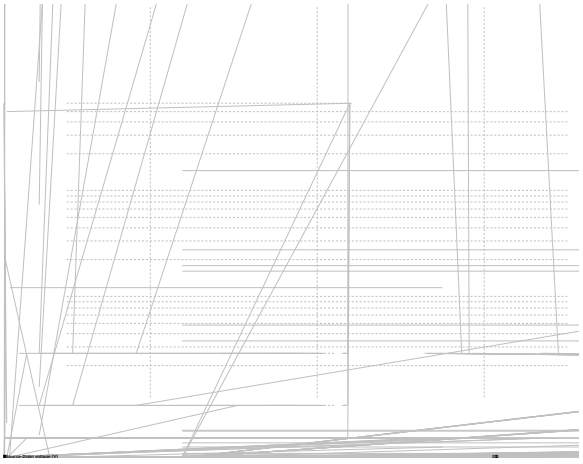

Figure 8. Forward characteristic of body diode

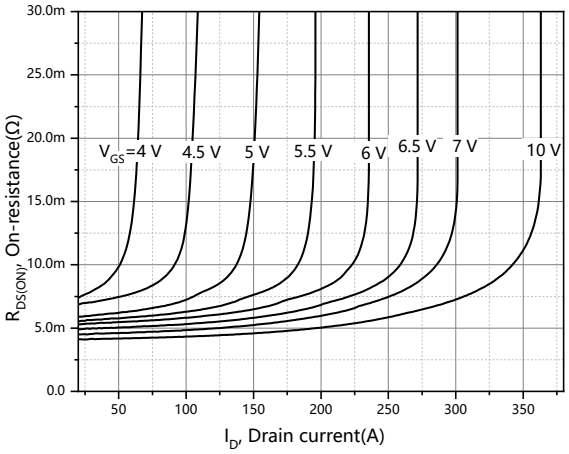

Figure 9. Drain-source on-state resistance

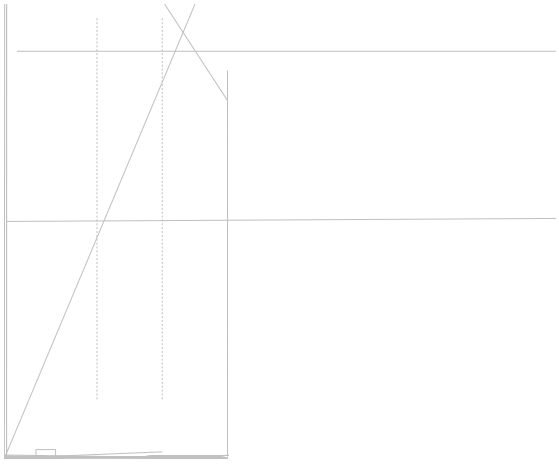

Figure 10. Drain current

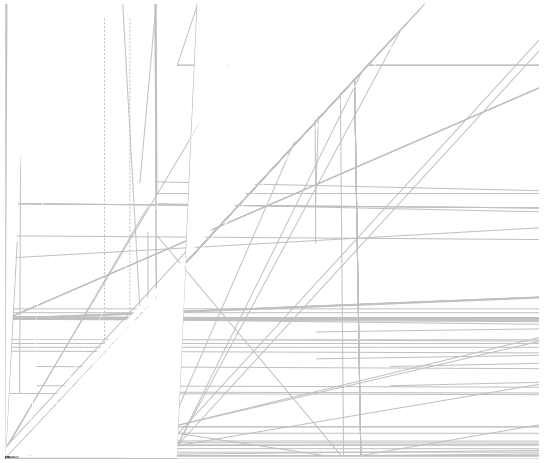

Figure 11. Safe operation area T_C=25 °C

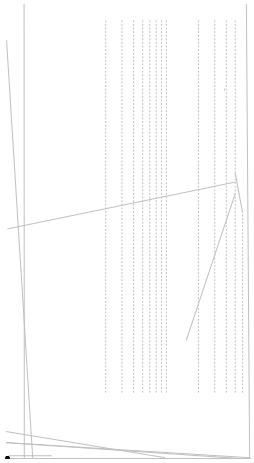

Figure 12. Max. transient thermal impedance

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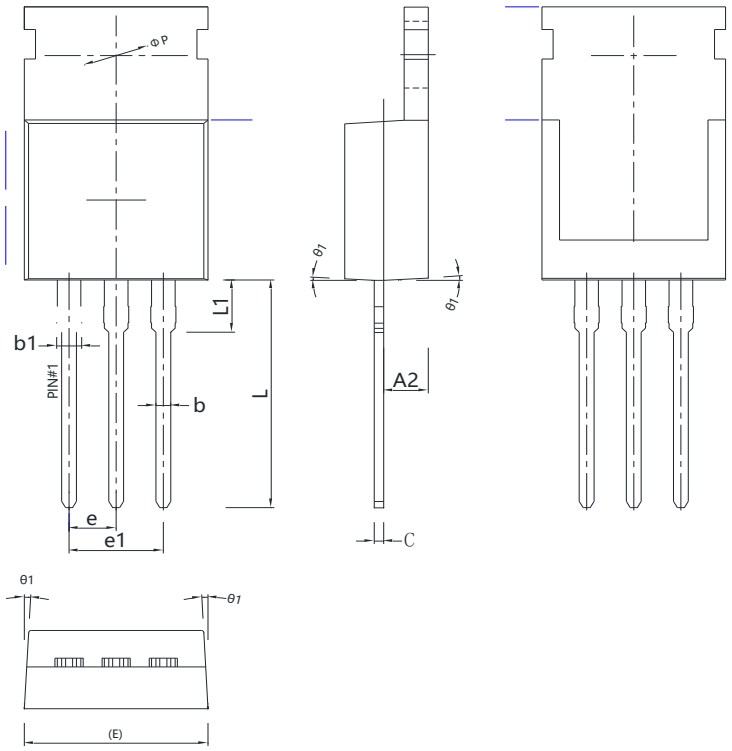
Package Information



Symbol	mm		
	Min	Nom	Max
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	-	0.90
b1	1.27	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70
E	9.70	9.90	10.20
E1	7.80	8.00	8.20
e	2.54 BSC		
e1	5.08 BSC		
H1	6.30	6.50	6.70
L	12.78	13.08	13.38
L1	-	-	3.50
L2	4.60 REF		
7	3.55	3.60	3.65
Q	2.73	-	2.87
1	1		

Version 1: TO220-J package outline dimension

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Ordering Information

Package Type	Units/ Tube	Tubes / Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO220-J	50	20	1000	5	5000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
SFS06R06PF	TO220	yes	yes	yes

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